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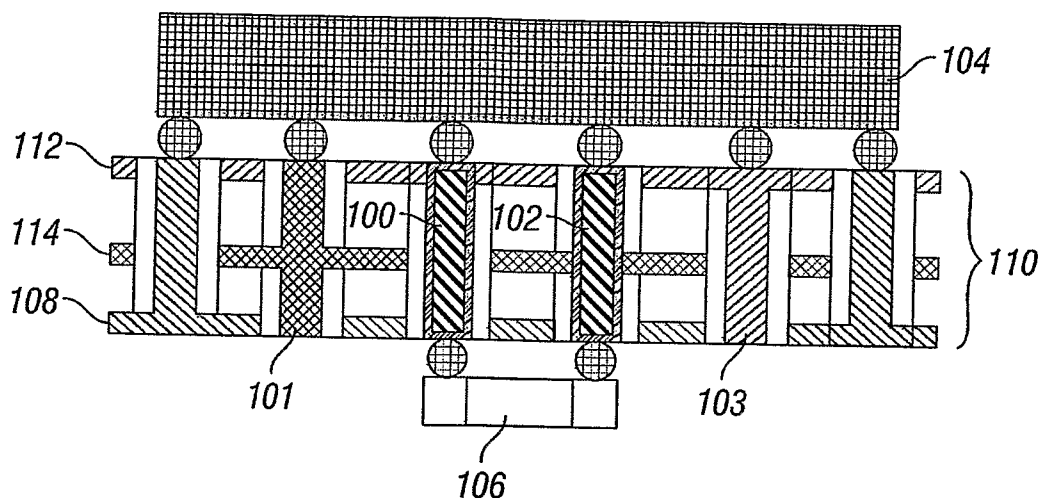
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(54) Title: CAPACITOR INTERCONNECTION



(57) Abstract: A substrate for power decoupling and a method of forming a substrate for power decoupling. The substrate comprises one or more decoupling capacitors; and one or more interconnections to the decoupling capacitors. At least one of the interconnec-
tions comprises a lossy material.

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